







Call for Papers

16th International Symposium on Electronics and Telecommunications (ISETC '24) Timisoara, România, November 07 – 08, 2024

The 16th International Symposium on Electronics and Telecommunications (ISETC '24) is organized by the Faculty of Electronics, Telecommunications and Information Technologies from the Politehnica University Timişoara, România and the Association of Electrical Engineers from Timişoara in cooperation with IEEE România Section, Com Chapter, SP/IT/COM Joint Chapter, and the Romanian Academy of Technical Sciences.

Conference Tracks

Artificial Intelligence and Computer Vision • Deep Learning, Reinforced Learning, Machine Learning • Fuzzy Systems, Evolutionary Computing • Computer Vision • Medical Imaging • Biometrics, Face Gesture and Body • Computational Photography • Natural Language Processing	Instrumentation and Measurement Instrumentation, sensors, measurement techniques and devices Industry 4.0 applications for smart manufacturing Electromagnetic Compatibility, Microwaves, Antennas and Propagation Biomedical Applications Robotic systems in enhanced perception, autonomous and intelligent integrations Automation solutions in dynamically reconfigurable manufacturing processes Real-Time applications for measurement techniques, data acquisition and processing	Open Education and Emerging Technologies Open Education: Open Access, Open Scholars, Open Educators, Open Learning, Open Educational Resources (OERs), Open Science, Open Data, etc. MOOCs and Flipped Classrooms, Blended Learning OERs and MOOCs for Industry Revolution 4.0 Digital Transformation of Higher Education for STE(A)M Subjects Advanced Learning Technologies and Game Based Learning AR/VR and Blockchain Technologies in Education Internet of Things Education	Power Electronics • Power Converters, Topologies and Design • Modern Control in Power Electronics • Renewable Energy Power Systems • Power Quality • Modelling and Simulation in Power Electronics • Grids, Smart Grids • Power Converters for Electric Vehicles
Signal Processing	Telecommunications	Microelectronics	Industry Workshop
Adaptive and Non-linear Signal Processing Statistical Signal Processing Signal analysis, Transform and Reconstruction Speech and Audio Signal Processing Compressive Sensing RADAR, Video and 3D Signal Processing Watermarking Model-Based Deep Learning applied in Signal processing for telecommunications	Security Antenna and Propagation Network and Service Management Telecom Software, Network Virtualization, and Software Defined Networks Data Science and Artificial Intelligence for Communications Design and Implementation of Devices, Circuits, and Systems Internet of Things and Sensor Networks 3G, 4G and 5G Communication Networks	Semiconductor Technologies Analog, Mixed and Digital ICs VLSI Technologies FPGA and Applications Integrated Circuits Fabrication Photonics and Optoelectronics Electronic packaging	Workshop sessions include presentations of technical innovations and applicative research solutions coming from important industry actors. • Automotive Trends • Communication Technologies & IoT • Smart Manufacturing • Others

Prospective authors are invited to submit four-page (recommended-length) papers using IEEE Conference Proceedings format. All papers will be electronically handled and reviewed using <u>EDAS</u> platform. Accepted papers, presented at the symposium, will be submitted for inclusion/indexing into major databases. Since 2010, ISETC Proceedings have been indexed into IEEE Xplore Digital Library, Web of Science, SCOPUS, etc.

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Deadline for submission of	June 30, 2024
papers:	
Notification of acceptance:	September
	22,2024
Deadline for submission of	October 01, 2024
camera-ready papers:	

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